

2SK2958(L), 2SK2958(S)

Silicon N Channel MOS FET High Speed Power Switching

REJ03G1058-0400

(Previous: ADE-208-568B)

Rev.4.00 Sep 07, 2005

Features

- Low on-resistance $R_{DS(on)} = 5.5 \text{ m}\Omega \text{ typ.}$
- 4 V gate drive devices.
- High speed switching

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	30	V
Gate to source voltage	V_{GSS}	±20	V
Drain current	I _D	75	А
Drain peak current	I _{D(pulse)} Note1	300	А
Body-drain diode reverse drain current	I _{DR}	75	А
Channel dissipation	Pch Note2	100	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1 %

2. Value at Tc = 25°C

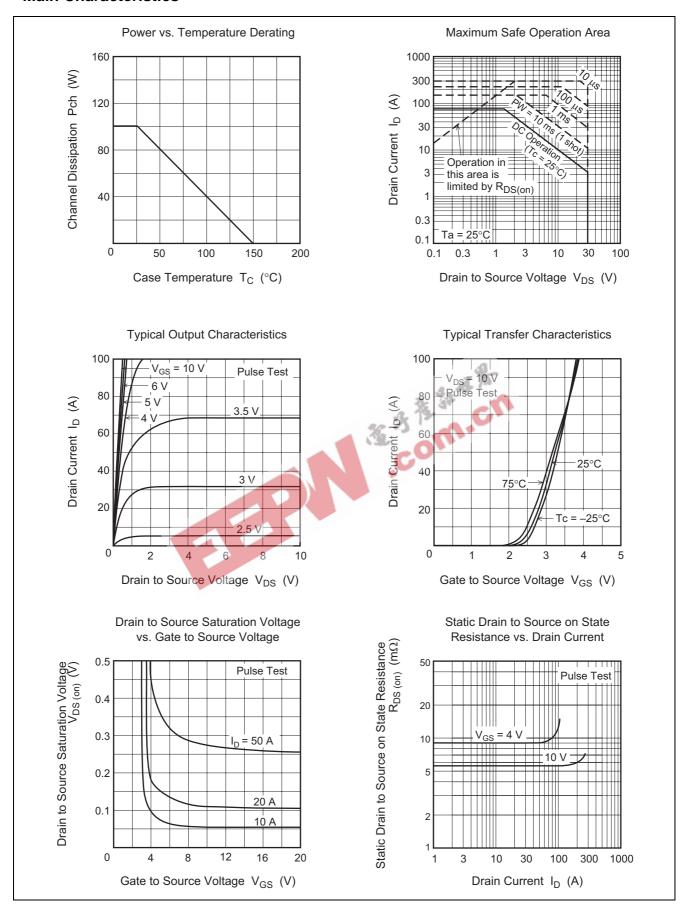
Electrical Characteristics

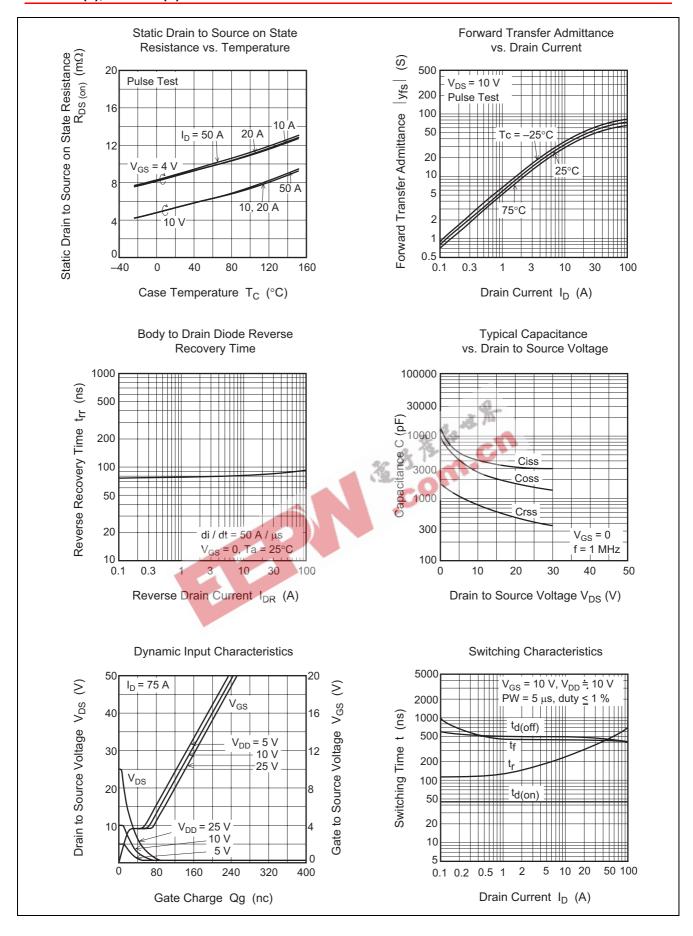
 $(Ta = 25^{\circ}C)$

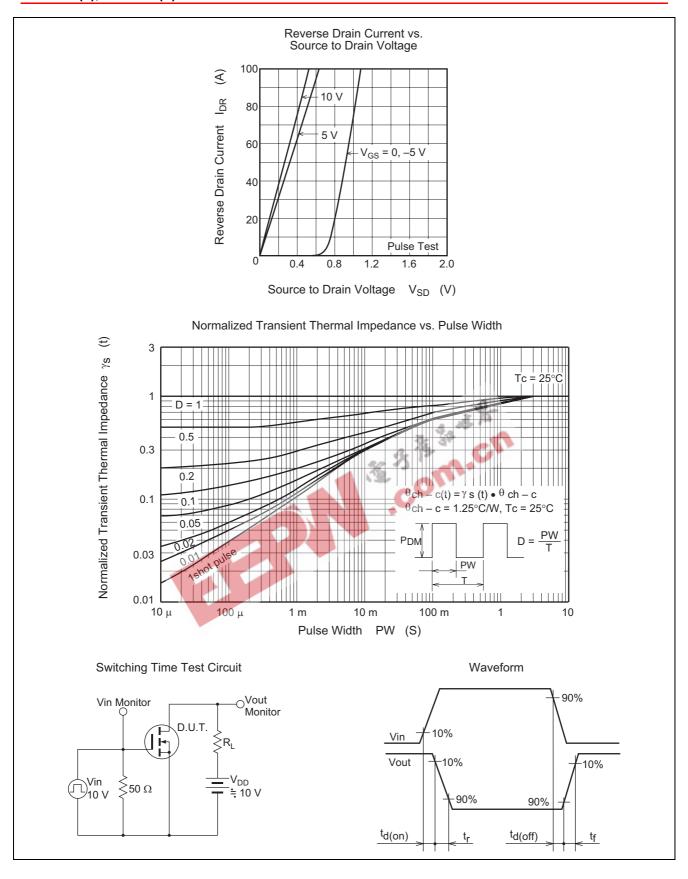
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	30	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	10	μΑ	$V_{DS} = 30 \text{ V}, V_{GS} = 0$
Gate to source leak current	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 1 \text{ 6V}, V_{DS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.0	_	2.0	V	$I_D = 1 \text{ mA}, V_{DS} = 10V$
Static drain to source on state	R _{DS(on)}	_	5.5	7.0	mΩ	$I_D = 40 \text{ A}, V_{GS} = 10 \text{V}^{\text{Note3}}$
resistance	R _{DS(on)}	_	9.0	14.0	$m\Omega$	$I_D = 40 \text{ A}, V_{GS} = 4V^{\text{Note3}}$
Forward transfer admittance	y _{fs}	35	6 0	, <u>~</u> O	S	$I_D = 40 \text{ A}, V_{DS} = 10 V^{\text{Note3}}$
Input capacitance	Ciss	4	4100	-	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$
Output capacitance	Coss	\mathcal{A}	2700		pF	f = 1 MHz
Reverse transfer capacitance	Crss	\prec	800	_	pF	
Turn-on delay time	t _{d(on)}		45	_	ns	$V_{GS} = 10 \text{ V}, I_D = 40 \text{ A},$
Rise time	t _r	_	430	_	ns	$R_L = 0.25 \Omega$
Turn-off delay time	t _{d(off)}	_	460	_	ns	
Fall time	t _f	_	440	_	ns	
Body-drain diode forward voltage	V_{DF}	_	1.0	_	V	$I_F = 75A, V_{GS} = 0$
Body-drain diode reverse	t _{rr}	_	90	_	ns	$I_F = 75A, V_{GS} = 0$
recovery time						$di_F/dt = 50 A/\mu s$

Note: 3. Pulse test

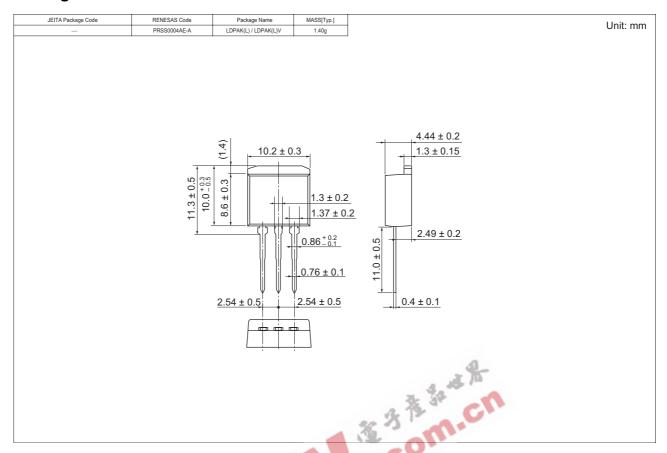
Main Characteristics

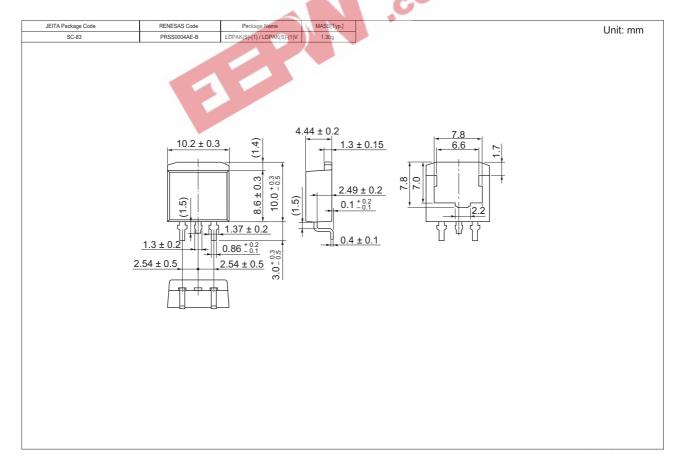






Package Dimensions





Ordering Information

Part Name	Quantity	Shipping Container
2SK2958L-E	500 pcs	Box (Sack)
2SK2958STL-E	1000 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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